2018년 2월 6일(화), 09:00-10:45 Room I (청옥II+III, 6층)

K. Memory (Design & Process Technology) 분과 [TI1-K] ReRAM I - Preparing for Mass Production

TI1-K-1 09:00-09:30	[초청] Highly Reliable Multi-Bit Operation in HfO ₂ Based Resistive Switching
	Device
	Gun Hwan Kim, Ji Woon Choi, Bo Keun Park, Taek-Mo Cheong, and Young Kuk
	Lee
	Center for Thin-Film Materials, KRICT
TI1-K-2 09:30-09:45	Roles of Conducting Filament and Non-Filament Regions in the Ta ₂ O ₅ and
	HfO ₂ Resistive-Switching Memory for Switching Reliability
	Tae Hyung Park ¹ , Hae Jin Kim ¹ , Soo Gil Kim ² , Byung Joon Choi ³ , and Cheol Seong Hwang ¹
	¹ Department of Materials Science and Engineering and Inter-University Semiconductor Research Center, Seoul National University, ² SK Hynix Inc., ³ Department of Materials Science and Engineering, Seoul National University of Science and Technology
TI1-K-3 09:45-10:00	Controlling Filament Forming Direction of Restive Switching Memory Device via Nanomesh Patterning Tae Jin Kim , Byoung Kuk You, Jong Min Kim, Daniel J. Joe, and Keon Jae Lee Department of Material Science and Engineering, KAISE
TI1-K-4 10:00-10:15	Selector for Bipolar Resistive Switching Material Having Current Saturation
	Functionality with Pt/Ti/TiO ₂ /HfO ₂ /TiN Device
	Daeeun Kwon, Jung Ho Yoon, Tae Hyung Park, Yumin Kim, Young Jae Kwon, Hae
	Jin Kim, and Cheol Seong Hwang
	Department of Materials Science and Engineering and Inter-university Semiconductor Research Center, Seoul National University
TI1-K-5 10:15-10:30	저항 변화층의 Initial Current Level과 저항 변화 특성 김명주, 한언빈, 김태우, 이한춘, 이상기, 이윤종 DB Hitek, 특화공정개발파트